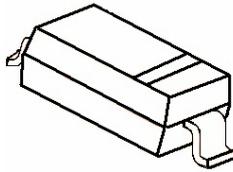


## SOD-123 贴片塑封开关二极管

### 350mW SOD-123 Fast Switching Diode

SOD-123



MARKING: 35XT



#### 特征 Features

- 开关速度小于 100nS; Fast Switching Device (TRR <100nS)
- 最大功率耗散 350mW; Power Dissipation of 350mW
- 高稳定性和可靠性。High Stability and High Reliability
- 反向漏电流小。Low reverse leakage

#### 机械数据 Mechanical Data

- 封装: SOD-123 封装 SOD-123 Small Outline Plastic Package
- 极性: 色环端为负极 Polarity: Color band denotes cathode end
- 环氧树脂 UL 易燃等级 Epoxy UL: 94V-0
- 安装位置: 任意 Mounting Position: Any

极限值和温度特性(TA = 25°C 除非另有规定)

**Maximum Ratings & Thermal Characteristics** (Ratings at 25°C ambient temperature unless otherwise specified.)

参数 Parameters	符号 Symbol	数值 Value	单位 Unit
反向电压 Reverse Voltage	V <sub>R</sub>	350	V
反向峰值电压 Peak Reverse Voltage	V <sub>RM</sub>	350	V
功率消耗 Power Dissipation	P <sub>d</sub>	350	mW
工作结温 Operating junction temperature	T <sub>j</sub>	150	°C
存储温度 Storage temperature range	T <sub>s</sub>	-65-+150	°C
反向工作电压 Working Inverse Voltage	W <sub>IV</sub>	75	V
平均整流电流 Average Rectified Current	I <sub>o</sub>	225	mA
典型热阻 Typical thermal resistance	R <sub>θJA</sub> R <sub>θJC</sub>	250 5	°C/W
正向(不重复)电流 Non-repetitive Peak Forward Current	I <sub>FM</sub>	300	mA
正向(不重复)浪涌电流 Peak Forward Surge Current	I <sub>FSM</sub>	1.0	A

@tp=1us; TA=25°C

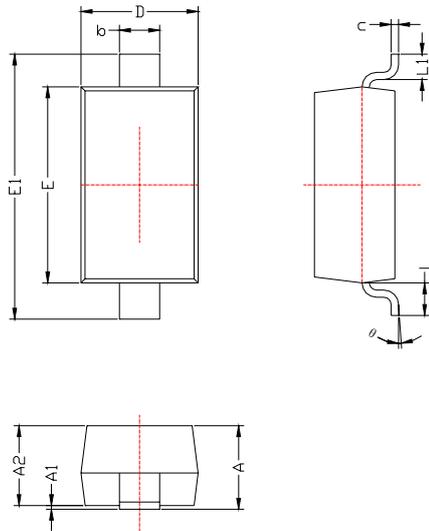
Valid provided that electrodes are kept at ambient temperature.

电特性 **Electrical Characteristics** (Ratings at 25°C ambient temperature unless otherwise specified).

符号 Symbols	参数 Parameter	测试条件 Test Condition	界限 Limits		单位 Unit
			Min	Max	
VRB	反向击穿电压 Reverse Voltage	I <sub>B</sub> =100uA	350	---	V
IR	反向漏电流 Reverse Leakage Current	V <sub>R</sub> =240V	---	100	nA
VF	正向电压 Forward Voltage	I <sub>F</sub> =20mA	---	0.87	V
		I <sub>F</sub> =100mA	---	1.00	
		I <sub>F</sub> =200mA	---	1.25	
TRR	反向恢复时间 Reverse Recovery Time	I <sub>F</sub> = 30mA, I <sub>R</sub> =30mA R <sub>L</sub> =100Ω I <sub>RR</sub> =3mA	---	100	nS
C	结电容 Capacitance	V <sub>R</sub> =0V, f=1MHZ	---	5	pF

SOD-123 PACKAGE OUTLINE

Plastic surface mounted package

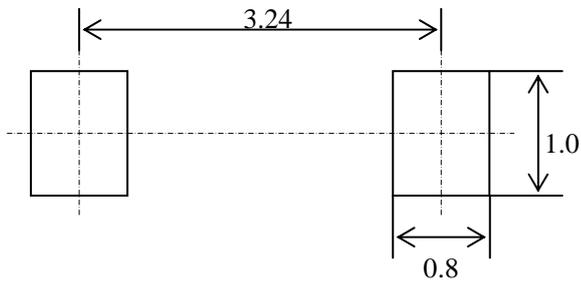


SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.450	0.650
c	0.080	0.150
D	1.500	1.700
E	2.600	2.800
E1	3.550	3.850
L	0.500REF	
L1	0.250	0.450
θ	0°	8°

焊盘设计参考

Precautions: PCB Design

Recommended land dimensions for SOD-123 diode. Electrode patterns for PCBs



中心距: 3.24  
 脚宽: 0.55  
 焊盘宽: 1.00  
 脚长: 0.50  
 焊盘长: 0.80

技术要求:

- 1, 塑封体尺寸: 2.70 X 1.60
- 2: 未注公差为: ±0.05
- 3, 所有单位: mm